

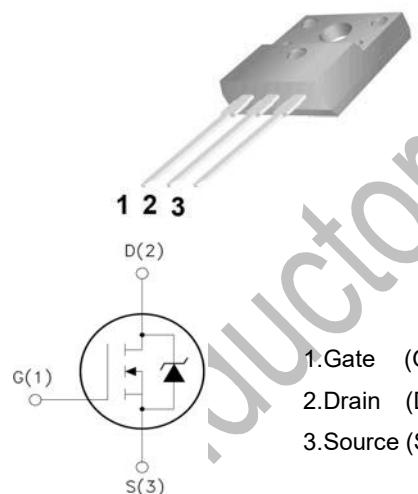


WGF20N70SE

Features:

- Low Intrinsic Capacitances.
- Excellent Switching Characteristics.
- Extended Safe Operating Area.
- Unrivalled Gate Charge : $Q_g=75\text{ nC}$ (Typ.).
- $V_{DSS}=700\text{V}, I_D=20\text{A}$
- $R_{DS(on)} : 0.45\Omega$ (Max) @ $V_G=10\text{V}$
- 100% Avalanche Tested

TO-220F

**Absolute Maximum Ratings (Ta=25°C unless otherwise noted)**

Symbol	Parameter	Value	Unit
V_{DSS}	Drain-Source Voltage	700	V
I_D	Drain Current	$T_c=25^\circ\text{C}$	20
		$T_c=100^\circ\text{C}$	12.5
V_{GSS}	Gate-Source Voltage	± 30	V
E_{AS}	Single Pulse Avalanche Energy (note1)	580	mJ
I_{AR}	Avalanche Current (note2)	20	A
P_D	Power Dissipation ($T_c=25^\circ\text{C}$)	84	W
T_j	Junction Temperature(Max)	150	$^\circ\text{C}$
T_{stg}	Storage Temperature	-55~+150	
T_L	Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds	300	

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JC}$	Thermal Resistance,Junction to Case	-	1.48	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance,Junction to Ambient	-	62.5	

Electrical Characteristics (Ta=25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
Off Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0	700	-	-	V
△BV _{DSS} /△TJ	Breakdown Voltage Temperature Coefficient	I _D =250μA, Reference to 25°C	-	0.71	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =700V, V _{GS} =0V V _{DS} =520V, Tc=125°C	-	-	10 100	μA
I _{GSSF}	Gate-body leakage Current, Forward	V _{GS} =+30V, V _{DS} =0V	-	-	100	nA
I _{GSSR}	Gate-body leakage Current, Reverse	V _{GS} =-30V, V _{DS} =0V	-	-	-100	nA
On Characteristics						
V _{GS(TH)}	Date Threshold Voltage	I _D =250μA, V _{DS} =V _{GS}	2	-	4	V
R _{DS(ON)}	Static Drain-Source On-Resistance	I _D =10A, V _{GS} =10V	-	0.38	0.45	Ω
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} =25V, V _{GS} =0, f=1.0MHz	-	3420	-	pF
C _{oss}	Output Capacitance		-	325	-	
C _{rss}	Reverse Transfer Capacitance		-	25	-	
Switching Characteristics						
T _{d(on)}	Turn-On Delay Time	V _{DD} =350V, I _D =20A R _G =25Ω (Note 3,4)	-	62	135	ns
T _r	Turn-On Rise Time		-	140	290	
T _{d(off)}	Turn-Off Delay Time		-	230	470	
T _f	Turn-Off Rise Time		-	65	140	
Q _g	Total Gate Charge	V _{DS} =520V, V _{GS} =10V, I _D =20A (Note 3,4)	-	75	98	nC
Q _{gs}	Gate-Source Charge		-	13.5	18	
Q _{gd}	Gate-Drain Charge		-	36	-	
Drain-Source Diode Characteristics and Maximum Ratings						
I _s	Max. Diode Forward Current	-	-	-	20	A
I _{SM}	Max. Pulsed Forward Current	-	-	-	80	
V _{SD}	Diode Forward Voltage	I _D =20A	-	-	1.4	V
T _{rr}	Reverse Recovery Time	I _s =20A, V _{GS} =0V diF/dt=100A/μs (Note 3)	-	530	-	nS
Q _{rr}	Reverse Recovery Charge		-	10.5	-	μC

Notes : 1, L=3.45mH, IAS=20A, VDD=50V, RG=25Ω, Starting TJ =25°C

2, Repetitive Rating : Pulse width limited by maximum junction temperature

3, Pulse Test : Pulse Width ≤ 300μs, Duty Cycle ≤ 2%

4, Essentially Independent of Operating Temperature

Typical Characteristics

Figure 1. On-Region Characteristics

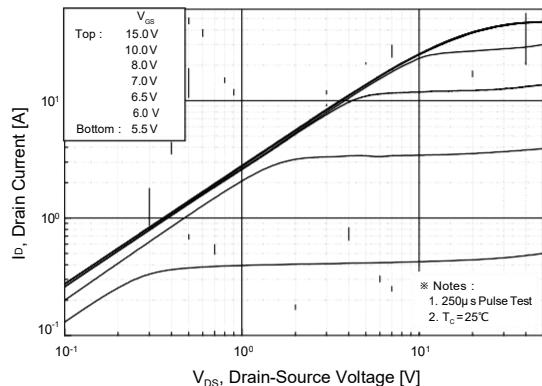


Figure 2. Transfer Characteristics

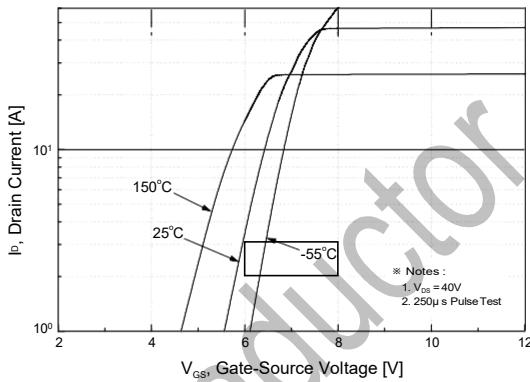


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

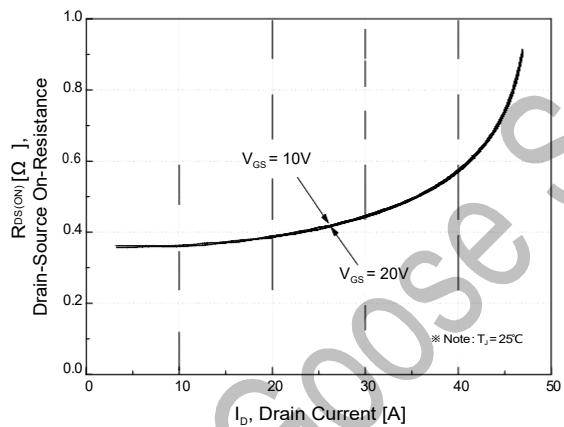


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

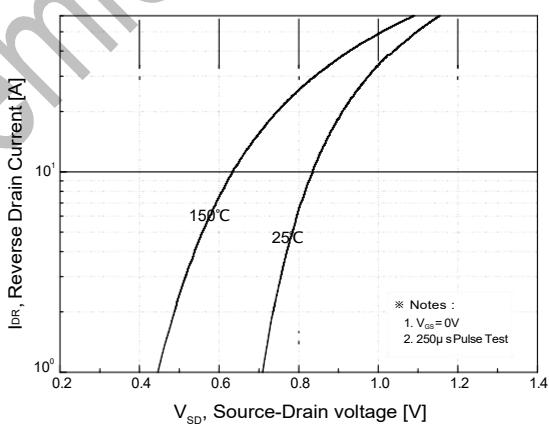


Figure 5. Capacitance Characteristics

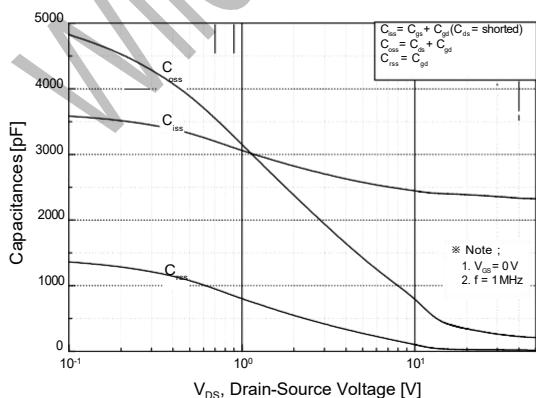
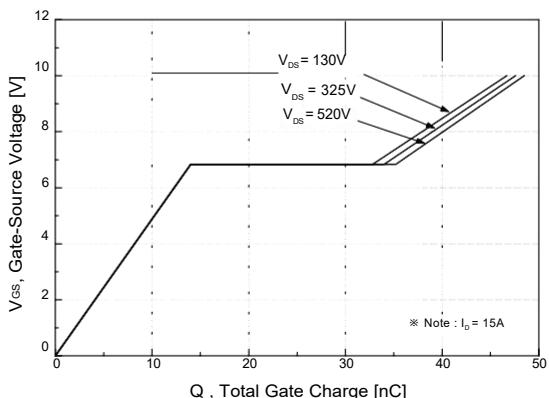


Figure 6. Gate Charge Characteristics



Typical Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

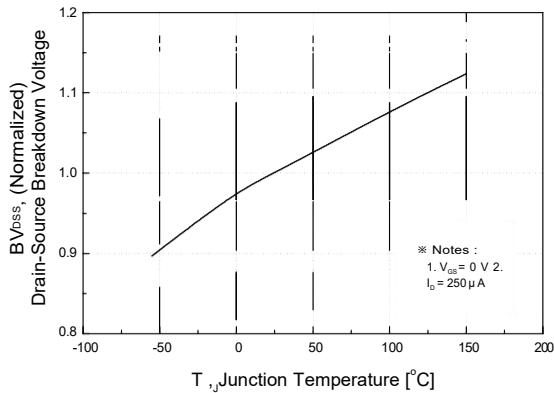


Figure 8. On-Resistance Variation vs. Temperature

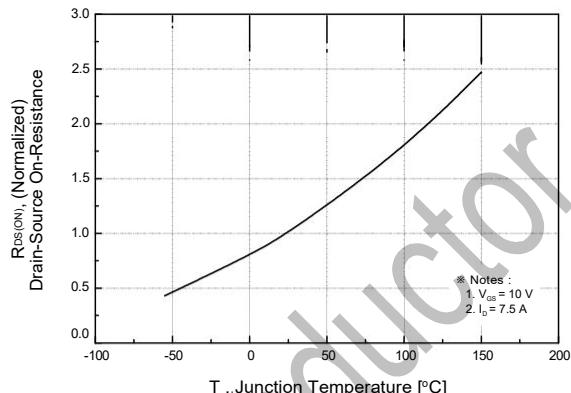


Figure 9 Safe Operating Area

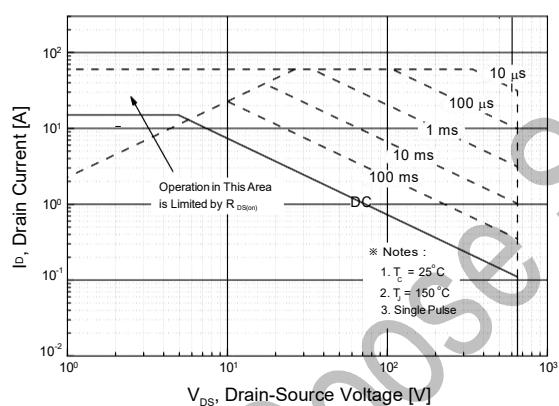


Figure 10. Maximum Drain Current vs. Case Temperature

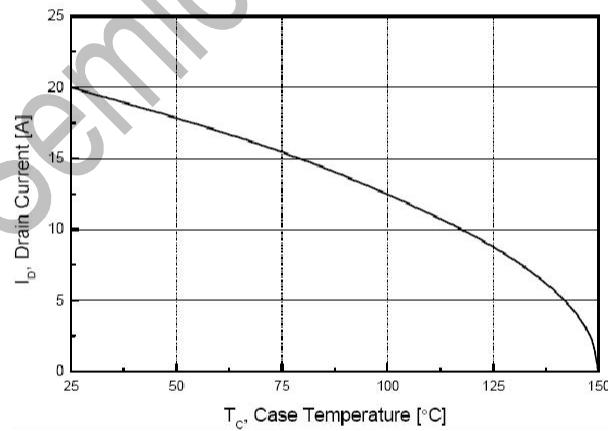
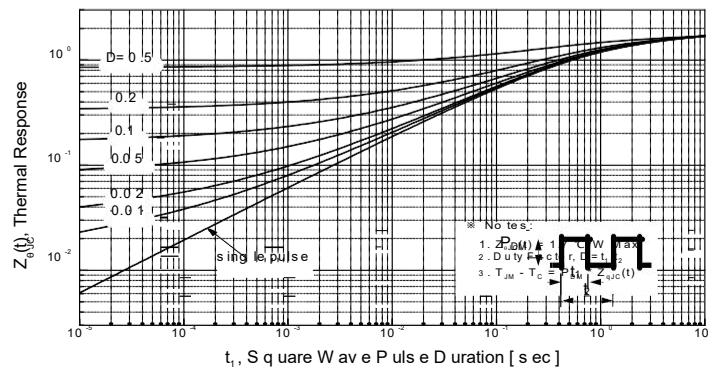
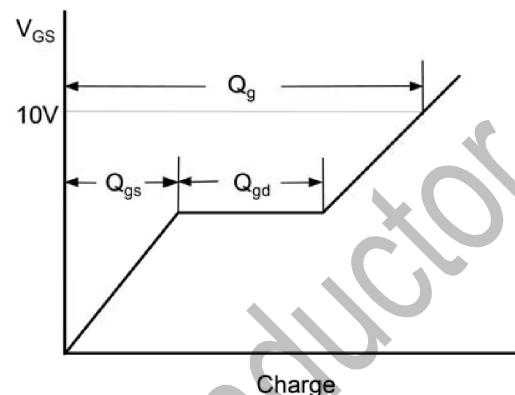
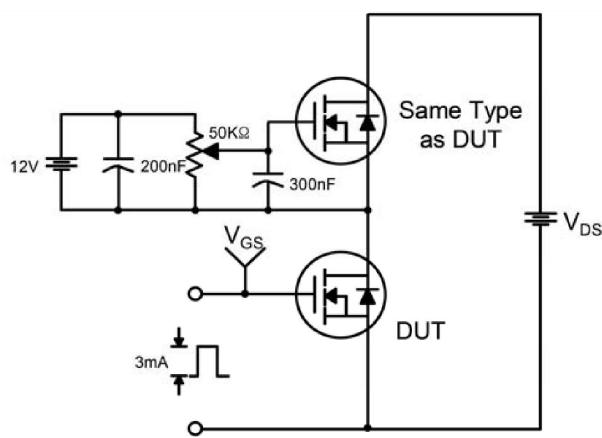
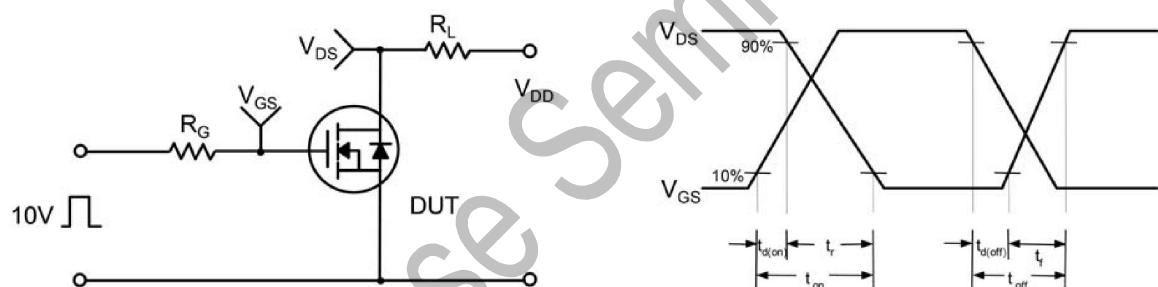
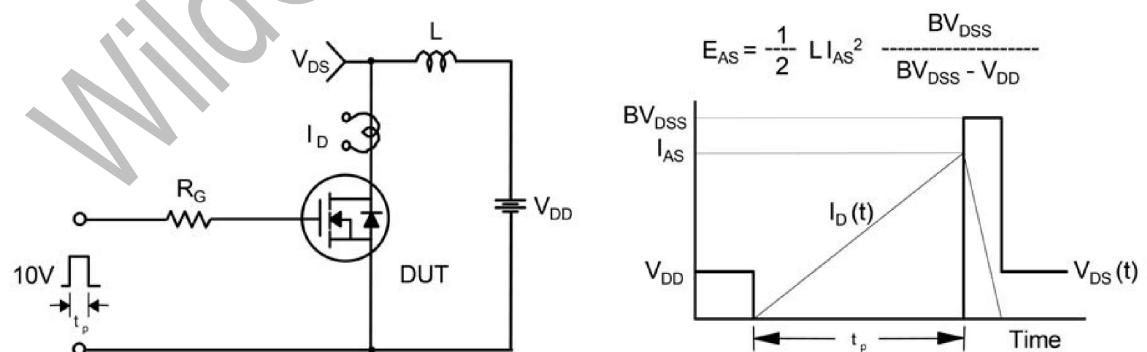
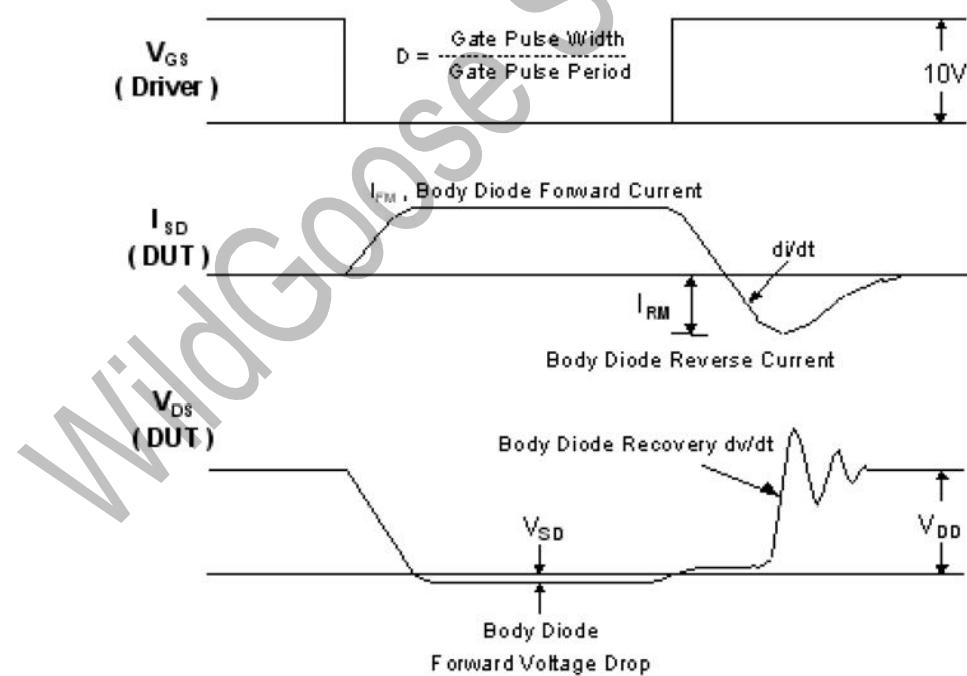
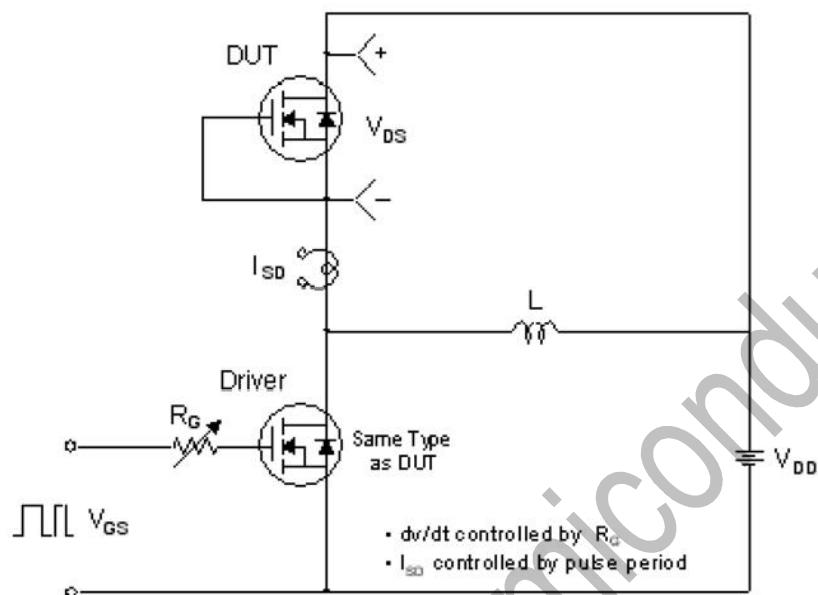


Figure 11 Transient Thermal Response Curve



Gate Charge Test Circuit & Waveform**Resistive Switching Test Circuit & Waveforms****Unclamped Inductive Switching Test Circuit & Waveforms**

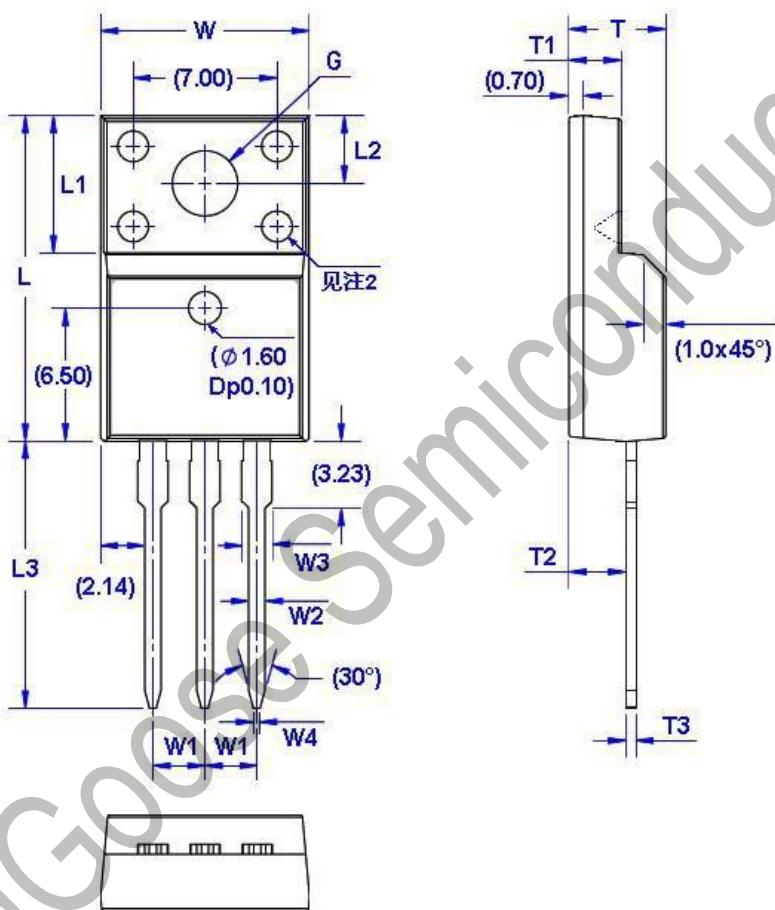
Peak Diode Recovery dv/dt Test Circuit & Waveform



Package Dimension

TO-220F

Unit: mm



Symbol	Size		Symbol	Size		Symbol	Size		Symbol	Size	
	Min	Max		Min	Max		Min	Max		Min	Max
W	9.96	10.36	W4	0.25	0.45	L3	12.78	13.18	T3	0.45	0.60
W1	2.54 (TYP)		L	15.67	16.07	T	4.50	4.90	G(Φ)	3.08	3.28
W2	0.70	0.90	L1	6.48	6.88	T1	2.34	2.74			
W3	1.24	1.47	L2	3.20	3.40	T2	2.56	2.96			